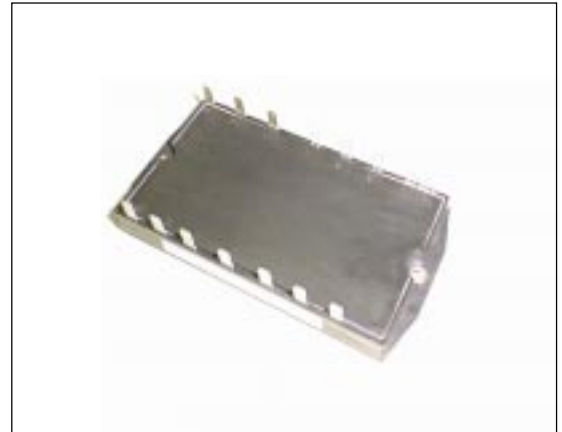


IGBT MODULE

600V / 50A / PIM



■ Features

- High Speed Switching
- Voltage Drive
- Low Inductance Module Structure
- Converter Diode Bridge Dynamic Brake Circuit

■ Applications

- Inverter for Motoe Drive
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply

■ Maximum ratings and characteristics

● Absolute maximum ratings (Tc=25°C unless without specified)

Item		Symbol	Condition	Rating	Unit
Inverter	Collector-Emitter voltage	V _{CES}		600	V
	Gate-Emitter voltage	V _{GES}		±20	V
	Collector current	I _C	Continuous	50	A
		I _{CP}	1ms	100	A
		-I _C		50	A
Collector power dissipation	P _C	1 device	200	W	
Brake	Collector-Emitter voltage	V _{CES}		600	V
	Gate-Emitter voltage	V _{GES}		±20	V
	Collector current	I _C	Continuous	50	A
		I _{CP}	1ms	100	A
	Collector power dissipation	P _C	1 device	200	W
	Repetitive peak reverse voltage	V _{RRM}		600	V
	Average forward current	I _{F(AV)}		1	A
Surge current	I _{FSM}	10ms	50	A	
Converter	Repetitive peak reverse voltage	V _{RRM}		800	V
	Non-Repetitive peak reverse voltage	V _{RSM}		900	V
	Average output current	I _O	50Hz/60Hz sine wave	50	A
	Surge current (Non-Repetitive)	I _{FSM}	T _j =150°C, 10ms	350	A
	I ² t (Non-Repetitive)		T _j =150°C, 10ms	648	A ² s
Operating junction temperature		T _j		+150	°C
Storage temperature		T _{stg}		-40 to +125	°C
Isolation voltage		V _{iso}	AC : 1 minute	AC 2500	V
Mounting screw torque				1.7 * ₁	N·m

*1 Recommendable value : 1.3 to 1.7 N·m (M4)

● Electrical characteristics (Tj=25°C unless without specified)

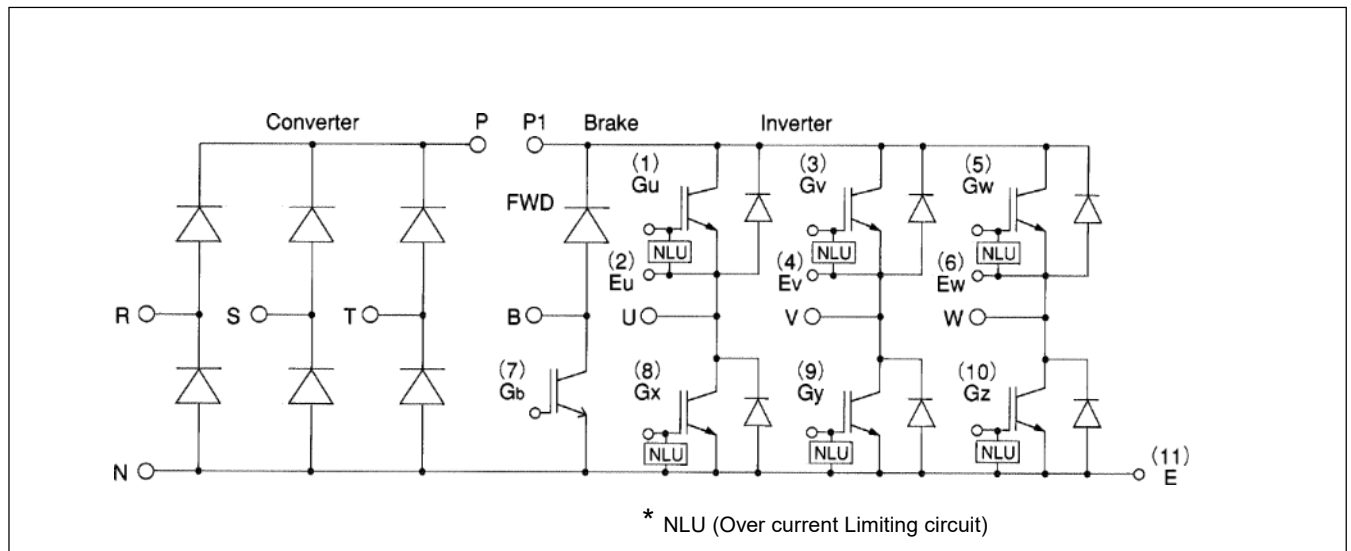
Item	Symbol	Condition	Characteristics			Unit
			Min.	Typ.	Max.	
Inverter (IGBT)	Zero gate voltage collector current	ICES	VCE=600V, VGE=0V		1.0	mA
	Gate-Emitter leakage current	IGES	VCE=0V, VGE=±20V		20	μA
	Gate-Emitter threshold voltage	VGE(th)	VCE=20V, Ic=50mA	4.5	7.5	V
	Collector-Emitter saturation voltage	VCE(sat)	VGE=15V, Ic=50A		2.8	V
	Collector-Emitter voltage	-VCE	-Ic=50A		3.0	V
	Input capacitance	Cies	VGE=0V, VCE=10V, f=1MHz	3300		pF
	Switching time	ton	VCC=300V		1.2	μs
		tr	Ic=50A		0.6	μs
		toff	VGE=±15V		1.0	μs
		trf	RG=51 ohm		0.35	μs
	Reverse recovery time of FRD	trr	IF=50A		0.3	μs
Brake (IGBT)	Zero gate voltage collector current	ICES	VCE=600V, VGE=0V		1.0	mA
	Gate-Emitter leakage current	IGES	VCE=0V, VGE=±20V		0.1	μA
	Collector-Emitter saturation voltage	VCE(sat)	Ic=50A, VGE=15V		2.8	V
	Switching time	ton	VCC=300V		0.8	μs
		tr	Ic=50A		0.6	μs
		toff	VGE=±15V		1.0	μs
		trf	RG=51ohm		0.35	μs
Brake (FWD)	Reverse current	IRRM	VR=600V		1.0	mA
	Reverse recovery time	trr			0.6	μs
Converter	Forward voltage	VFM	IF=50A		1.55	V
	Reverse current	IRRM	VR=800V		1.0	mA

● Thermal Characteristics

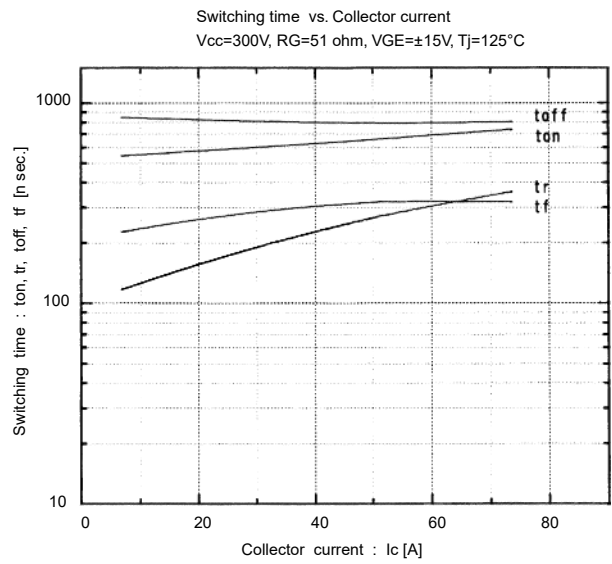
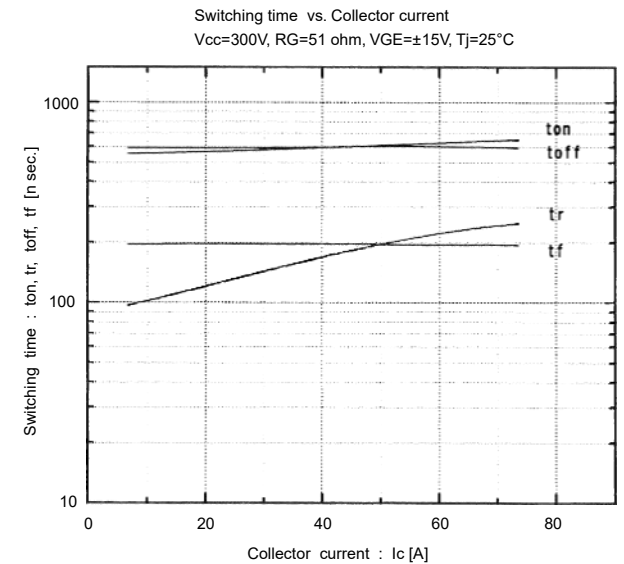
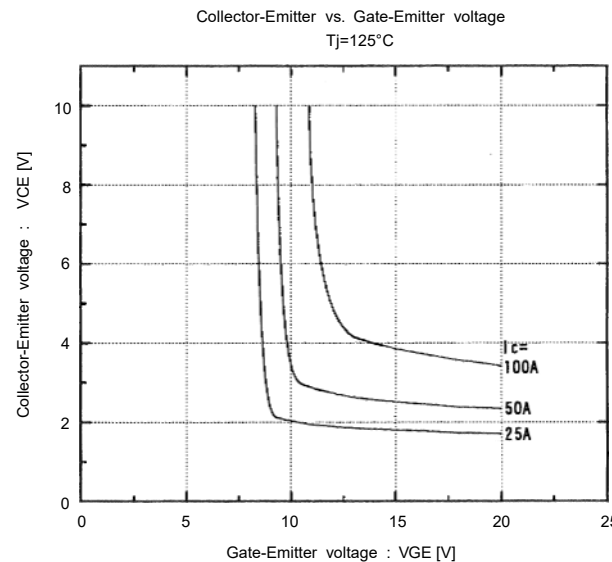
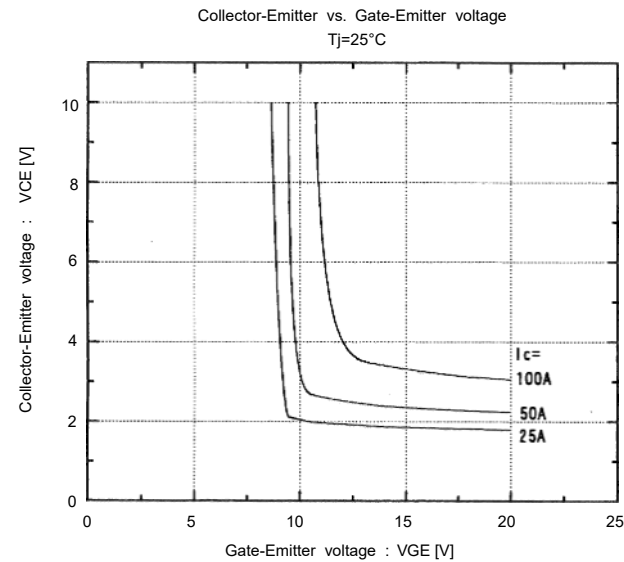
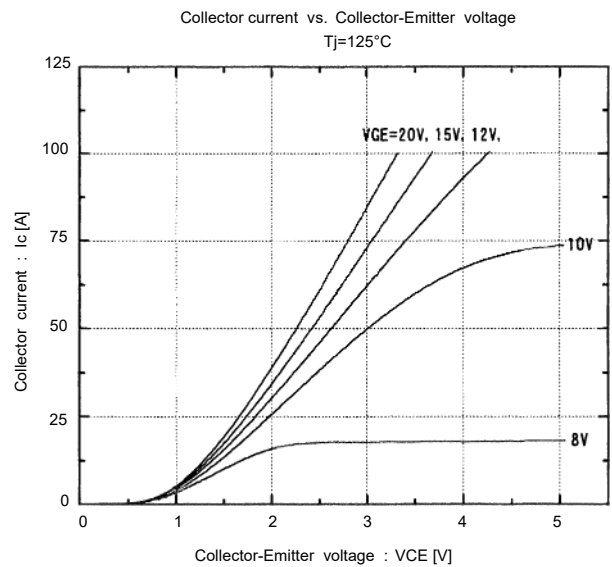
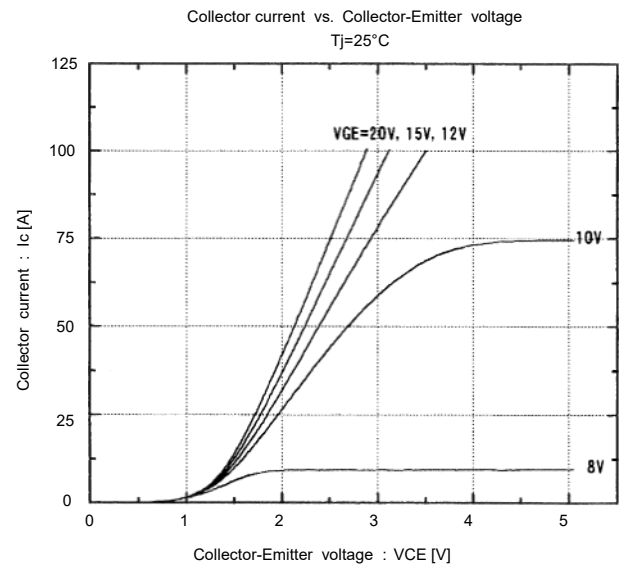
Item	Symbol	Condition	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance (1 device)	Rth(j-c)	Inverter IGBT			0.63	°C/W
		Inverter FRD			1.60	
		Brake IGBT			0.63	
		Converter Diode			2.10	
Contact thermal resistance *	Rth(c-f)	With thermal compound		0.05		

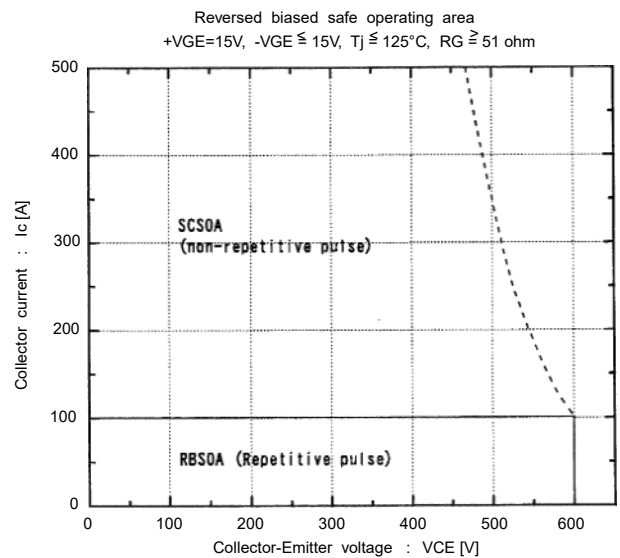
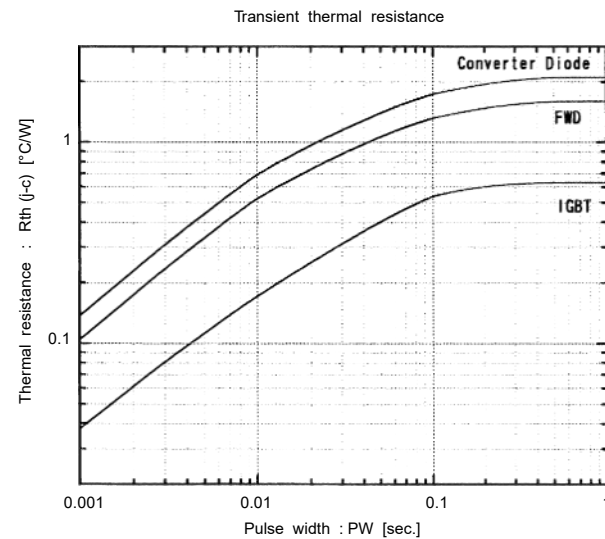
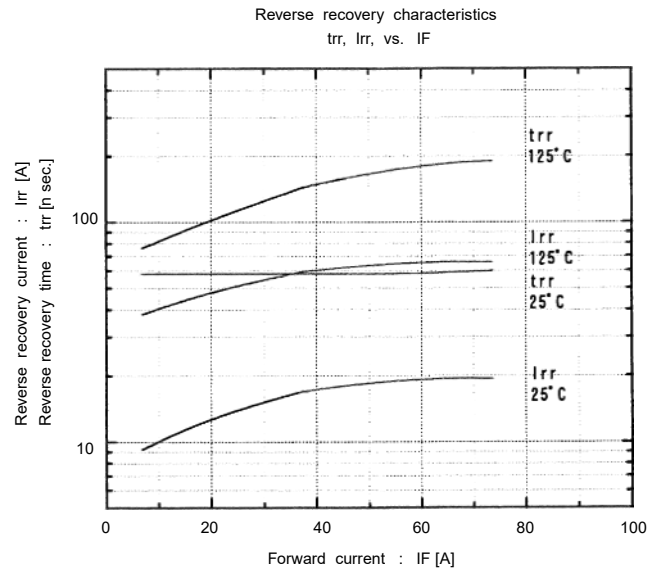
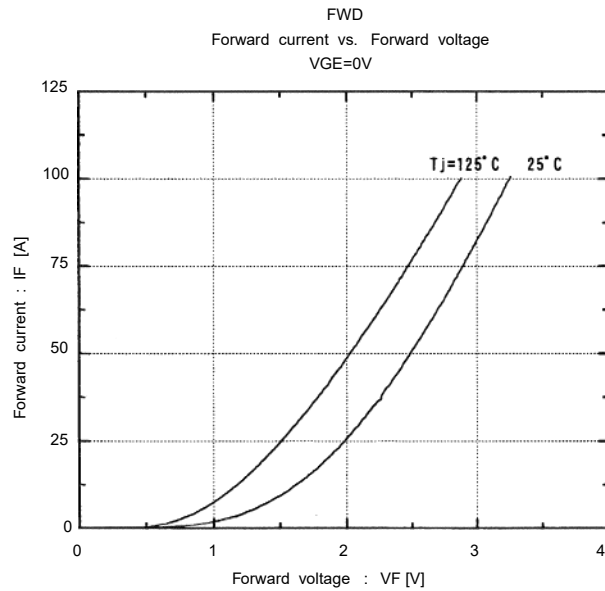
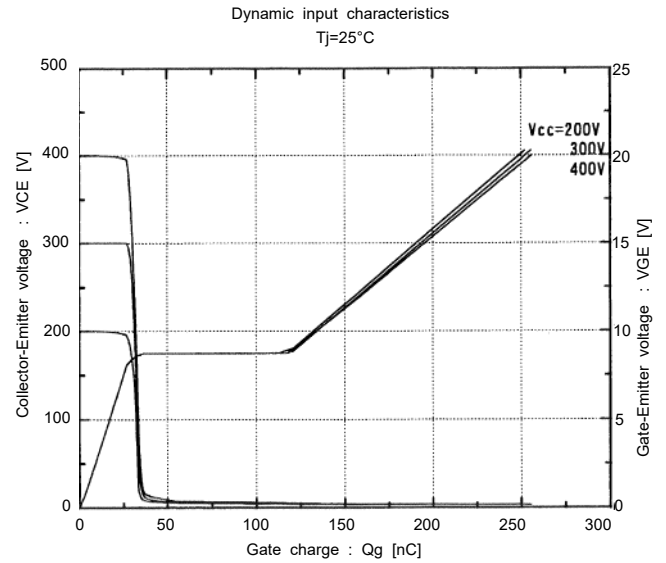
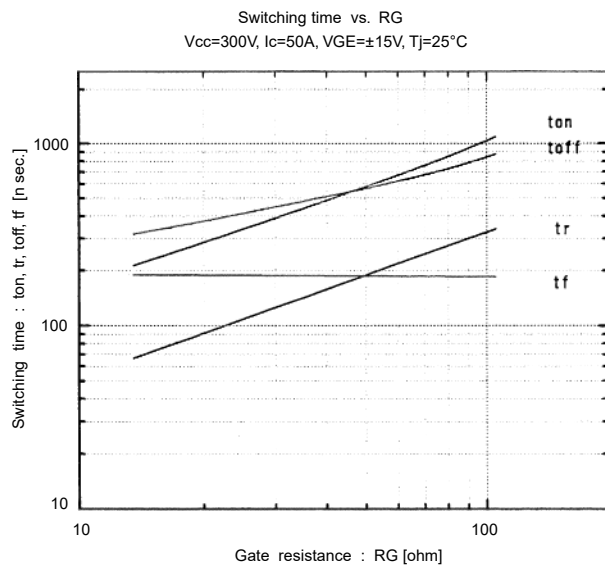
* This is the value which is defined mounting on the additional cooling fin with thermal compound

■ Equivalent Circuit Schematic

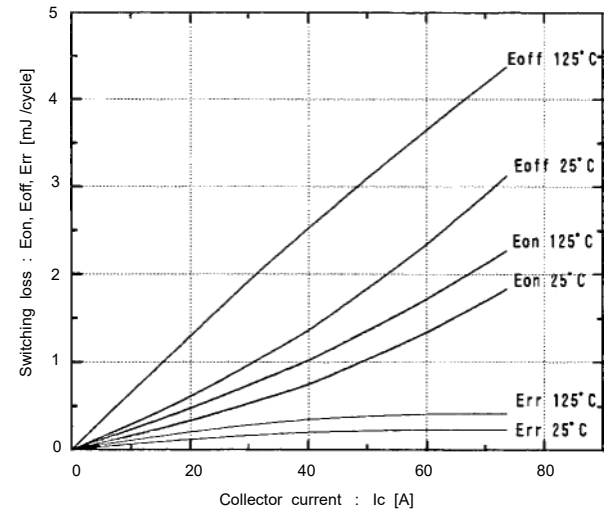


■ Characteristics (Representative)

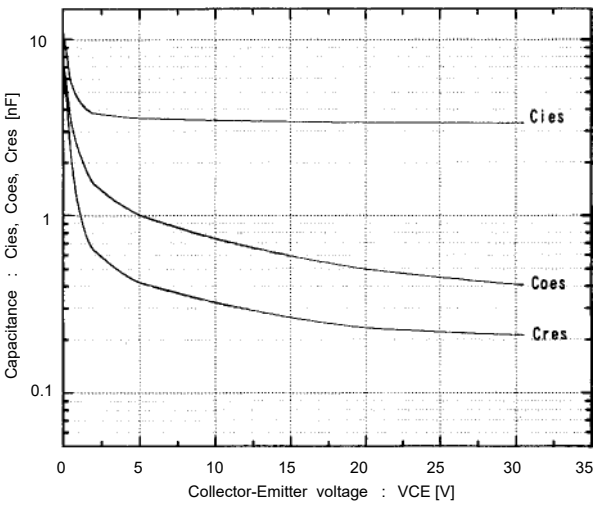




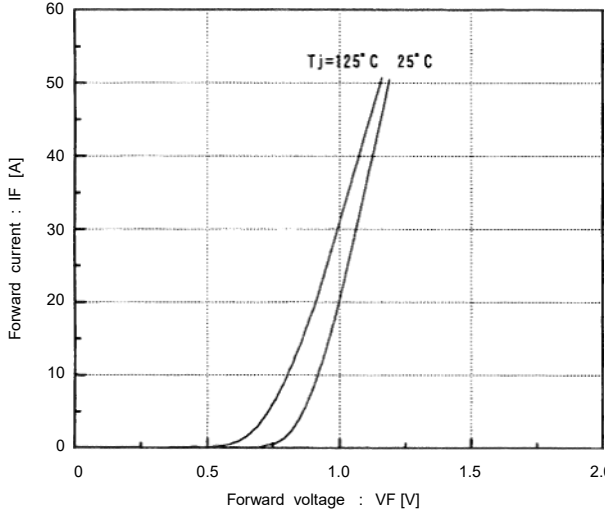
Switching loss vs. Collector current
 $V_{CC}=300V$, $R_G=51\ \Omega$, $V_{GE}=\pm 15V$



Capacitance vs. Collector-Emitter voltage
 $T_J=25^\circ C$



Converter Diode
Forward current vs. Forward voltage



■ Outline Drawings, mm

